

In series

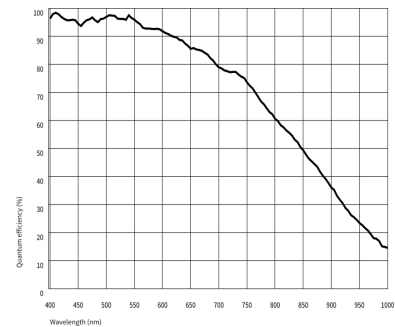
The model is in series and available for the long term.



Specification

Sensor

Sensor type	CMOS Mono
Shutter	Rolling shutter
Sensor characteristic	Linear
Pixel Class	13 MP
Resolution	12.62 Mpix
Resolution (h x v)	3552 x 3552 Pixel
Aspect ratio	1:1
ADC	12 bit
Color depth (camera)	12 bit
Optical sensor class	1/1.6"
Optical Size	7.104 mm x 7.104 mm
Optical sensor diagonal	10.05 mm 1/1.6"
Pixel size	2 μm
CRA (Chief Ray Angle)	12 °
Manufacturer	Sony
Sensor Model	IMX676-AAMR1-C
Gain (master/RGB)	31.6x/-
AOI horizontal	same frame rate
AOI vertical	increased frame rate
AOI image width / step width	1056 / 48
AOI image height / step width	836 / 4
AOI position grid (horizontal/vertical)	2 / 4
Binning horizontal	increased frame rate
Binning vertical	increased frame rate
Binning method	Horizontal: mean / Vertical: mean
Binning factor	2x2
Decimation (subsampling) horizontal	-
Decimation (subsampling) vertical	-
Decimation (subsampling) method	-



Model

Frame rate freerun mode	17 fps @ 10Bit
Frame rate trigger (continuous)	17 fps @ 10Bit
Frame rate trigger (maximum)	17 fps @ 10Bit
Exposure time (minimum - maximum)	0.031 ms - 1999 ms
Long exposure (maximum)	120034 ms
Power consumption	1 W - 1.3 W
Image memory	-

HDR

Mode	ClearHDR
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Ambient conditions

For PCB versions, refer to the separate hints in the respective documentation.

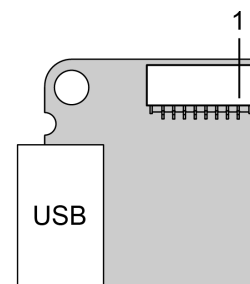
Allowed device temperature during operation	0 °C - 55 °C / 32 °F - 131 °F
Allowed device temperature during storage	-20 °C - 80 °C / -4 °F - 176 °F
Humidity (relative, non-condensing)	20 % - 80 %

Connectors

Interface connector	USB 3.0 micro-B
I/O connector	8-pin Wuerth connector
Power supply	USB cable

Pin assignment I/O connector

1	Voltage output 3.3 V
2	Ground (GND)
3	Flash output without optocoupler - Line 1
4	Trigger input without optocoupler - Line 0
5	General Purpose I/O (GPIO) 1 - Line 2
6	General Purpose I/O (GPIO) 2 - Line 3
7	Ground (GND)
8	USB Power: 5 V, max. 400 mA



Design

Lens Mount	CS- / C-Mount
IP code	-
Dimensions H/W/L	32.5 mm x 32.5 mm x 14.0 mm
Mass	17 g
Housing material	-

Features

List of on-camera image pre-processing features.

All features of the table are available via our IDS peak software for image pre-processing on the host computer (sensor model dependent).

U3-34L4XLS-M-GL Rev.1.2 (1010748)

Image Acquisition	Freerun	✓
	Software trigger	✓
	Hardware trigger	✓
	Trigger controlled exposure	-
	Denoiser	-
	Long exposure	✓
	Line scan	-
	Global start	-
Flashing	Flashing	-
	PWM flashing	-
Image Adjustments	Auto exposure	-
	Auto gain	-
	Auto whitebalance	-
	Color correction	-
	Gamma	-
	LUT	-
	Mirror/flip	X/Y
On-board Image Processing	Pixel formats	Mono10g40IDS Mono12g24IDS
	Region of interest	✓
	Decimation (FPGA)	-
	Decimation (Sensor)	-
	Binning (FPGA)	-
	Binning (Sensor)	2x2 Increases frame rate.
Others	Chunks	-
	Sequencer	-
	Events	-
	Firmware update	✓
	1st supported firmware version	3.34